

ICN2027

(16-Channel Constant Current LED Sink Driver)



Description

The ICN2027 is a 16-channel constant current sink output LED driver. All 16-channels constant current can be set by a single external resistor, which provides users flexibility in controlling the light intensity of LEDs.

The ICN2027 contains 16-bit shift registers and latches which convert serial input data into parallel output format, therefore, the ON or OFF of LED can be controlled by an external enable signal $\overline{\it OE}$. And ICN2027 exploits current precision controlling technology, which makes error between ICs less than ±2.5%, and error between channels less than ±1.3%. At ICN2027 output stage, 16-regulated output ports are designed to provide uniform and constant current sinks for driving LEDs within a large range of forward voltage(V_F) variations. The high clock frequency, 30MHz, also satisfies the system requirements of high volume data transmission.

Features

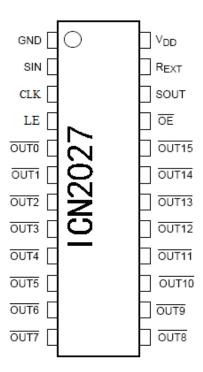
- ♦ 16 channel constant-current output
- ♦ Output current setting range: 3~65mA×16@V_{DD}=5V constant current output 3~30mA×16@V_{DD}=3.3V constant current output
- ♦ Current accuracy
 Between channel :< ±1.3%
 Between ICs :< ± 2.5%
- 16 channels maximum voltage 17V
- → I/O: Schmitt trigger input
- ♦ Data transfer frequency:f_{MAX}=30MHz(Max)
- ♦ Power supply voltage: V_{DD}=3.3~5V
- ♦ Operating Temperature: –40°C to +85°C
- ♦ Pre-Charge for Ghosting Reduction



ICN2027



Pin Configuration



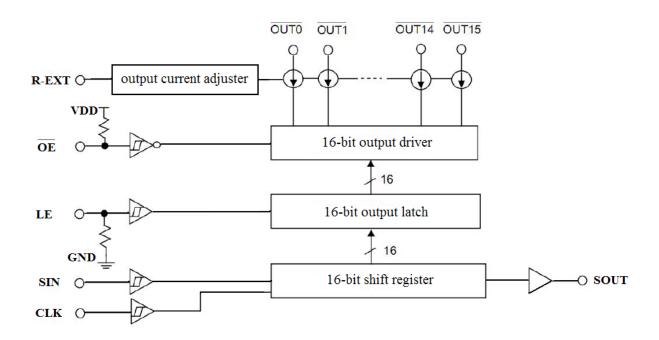
ICN2027

Pin Description

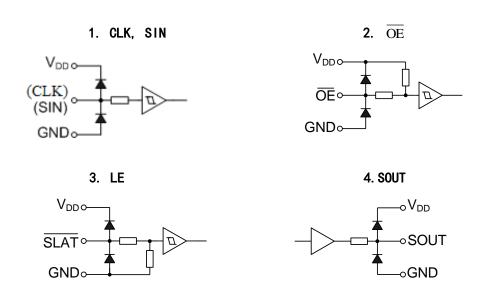
Pin Name	Function
GND	Power Ground
SIN	Serial data input for driver control
CLK	Clock input terminal for data shift on rising edge
LE	Edge triggered latch. LE high level, serial data is transferred to the output latch;
LE	LE low level, the data is latched
OUTO ~ OUT15	Constant current output
ŌĒ	Output enable terminal, $\overline{ ext{OE}}$ high level, all output drivers are enabled; OE low level,
OE.	all output drivers are turned OFF
SOUT	Serial-data output to the following IC.
R-EXT	Constant-current value setting . Connection to an external resistor to GND.
VDD	Power-supply voltage



Block Diagram

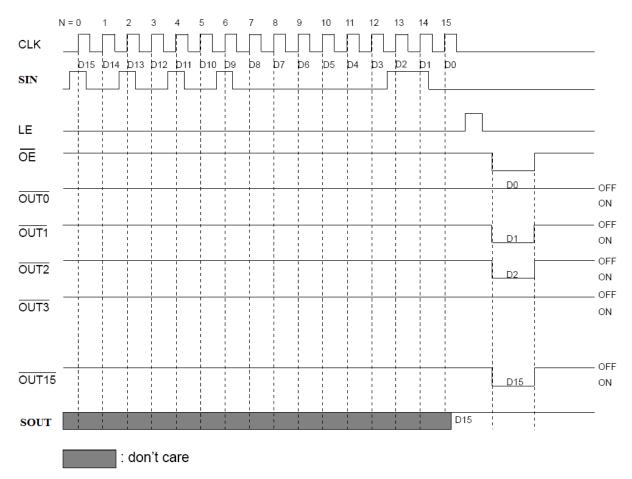


I/O Equivalent Circuits





Timing Diagram



Note 1: Keep the LE pin is set to L to enable the latch circuit to hold data. When the LE pin is set to H, the latch circuit does not hold data. The data will instead pass onto output. When the $\overline{_{OE}}$ pin is set to L, the $\overline{_{OUT15}}$ to $\overline{_{OUT15}}$ output pins will go ON and OFF in response to the data. In addition, when the $\overline{_{OE}}$ pin is set to H all the output pins will be forced OFF regardless of the data.



Truth Table

CLK	LE	ŌĒ	SIN	OUTO ··· OUT7 ··· OUT15	SOUT
	Н	L	D _n	$D_n \cdots D_{n-7} \cdots D_{n-15}$	D _{n-15}
_	L	L	D _{n+1}	No Change	D _{n-14}
	Н	L	D _{n+2}	$D_{n+2} \cdots D_{n-5} \cdots D_{n-13}$	D _{n-13}
Ŧ	×	L	D _{n+3}	$D_{n+2} \cdots D_{n-5} \cdots D_{n-13}$	D _{n-13}
Ŧ	×	Н	D _{n+3}	0FF	D _{n-13}

Maximum Ratings (T_a =25℃)

Characteristics		Symbol	Rating	Unit
Supply Voltage		$V_{ exttt{DD}}$	0~7.0	V
Output Current		I _o	65	mA
Input Voltage		V _{IN}	-0. 4~V _{DD} +0. 4	٧
Output voltage	Output voltage		11V	
Clock Frequency	Clock Frequency		30	MHz
GND Terminal Current		I _{GND}	+1000	mA
Power Dissipation (On PCB, 25℃)	DN-type	P _D	3. 19	W
Thermal Resistance DN-type		$R_{th(j-a)}$	39. 15	°C/W
Operating Temperature		T_{opr}	−50 ~ 85	°C
Storage Temperature		T_{stg}	−55 [~] 150	°C

DC Items (Unless otherwise specified, T_a =-40 °C ~85 °C)

Characteristics	Symbol	Test Conditions	Min	Тур	Max	Unit
Power Supply Voltage	V_{DD}	-	3. 3	5	6. 0	٧
Output Voltage when ON	V _{O (ON)}	OUTn	0.6	-	4	٧
High level logic input voltage	V _{IH}	-	0. 7*V _{DD}	1	$V_{ extsf{DD}}$	٧
High level logic input voltage	VIL	-	GND	1	0. 3*V _{DD}	٧
SOUT high level output Current	I _{OH}	V _{DD} =5V	-	-	-1	mA
SOUT low level output Current	I _{OL}	V _{DD} =5V	- 1	-	1	mA
Constant current output	I ₀	OUTn	0. 5	_	65	mA



Transition Items (Unless otherwise specified, V_{DD}=4.5~5.5V, T_a =-40℃~85℃)

Characteristics	Symbol	Test circuit	Test Conditions	Min	Тур	Max	Unit
Serial data transfer frequency	F _{CLK}	6	-	-	-	35	MHz
Clock pulse width	t _{wCLK}	6	SCK=H or L	20	-	-	ns
Latch pulse width	t _{wLE}	6	LE=H	20	-	_	ns
Enable pulse width	$t_{\mathtt{w0E}}$	6	\overline{OE} =H or L, R _{EXT} =890 Ω	40	-	1	ns
Hold time	t _{HOLD1}	6	_	5	-	-	ns
Hold time	t _{HOLD2}	6	_	5	-	-	ns
Cotup time	t _{SETUP1}	6	_	5	-	-	ns
Setup time	t _{SETUP2}	6	_	5	-	_	ns
Maximum clock rise time	t _r	6		_	-	500	ns
Maximum clock fall time	t _f	6		_	-	500	ns

Electrical Characteristics (Unless otherwise specified, V_{DD} =4.5~5.5V, T_a =25℃)

Characteristics	Symbol	Test circuit	Test Conditions	Min	Тур	Max	Unit
High level logic output voltage	V _{OH}	1	I _{OH} =-1mA, SOUT	V _{DD} -0. 4	-	$V_{ exttt{DD}}$	٧
Low level logic output voltage	V _{oL}	1	I _{OH} =+1mA, SOUT	_	_	0. 4	٧
High level logic input current	I _{IH}	2	$V_{\text{IN}} = V_{\text{DD}}, \ \overline{\mathrm{OE}}$, SIN, CLK	_	-	1	μ Α
Low level logic input circuit	I IL	3	V _{IN} =GND, LE, SIN, CLK	_	ı	-1	μ Α
	I _{DD1}	4	Rext=open, OUT off	_	2. 5	5. 0	mA
	I DD2	4	Rext=1.24k Ω , OUT off	_	4. 5	7. 0	mA
Power supply current	I DD3	4	Rext=620Ω, OUT off	_	6	9. 0	mA
	I _{DD4}	4	Rext=1.24k Ω , OUT on	_	5. 2	8. 5	mA
	I DD5	4	Rext=620Ω, OUT on	_	6. 5	9. 5	mA
Constant surrent sutaut	I ₀₁	5	V_{DD} =5. 0V, V_{0} =1. 0V, R_{EXT} =1. 23k Ω	-	15	-	mA
Constant current output	I ₀₂	5	V _{DD} =5. 0V, V _D =1. 0V, R _{EXT} =615 Ω	-	30	-	mA
Constant current error	ΔΙο	5	V_{DD} =5. 0V, V_{O} =1. 0V, R_{EXT} =1. 23k Ω , $OUTO^{\circ}OUT15$	-	± 0. 15	± 0. 37	mA
Constant current power supply voltage regulation	%V _{DD}	5	V_{DD} =4.5 $^{\circ}$ 5.5V, V_{0} =1.0V, $\frac{R_{EXT}$ =1.24k Ω , $\frac{OUT_{0}}{OUT_{15}}$	-	±0.2	-	%/V
Constant current output voltage regulation	%V оит	5	V_{DD} =5. 0V, V_0 =1. 0~3. 0V, $\frac{R_{EXT}$ =1. 24k Ω , $\frac{OUT0}{OUT15}$	-	±0.1		%/V
Pull-up resistor	Rup	3	ŌĒ	250	500	800	kΩ
Pull-down resistor	R _{DOWN}	2	LE	250	500	800	kΩ

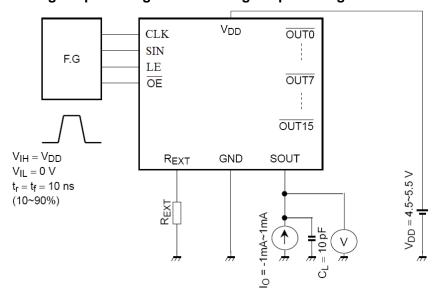


Switching Characteristics (Unless otherwise specified, T_a =25℃, V_{DD} =5.0V)

Characteris	tics	Symbol	Test circuit	Test conditions	Min	Тур	Max	Unit
	CLK-OUTO	t _{pLH1}	6	LE=H, OE =L	-	35	45	
	LE-OUT0	t _{pLH2}	6	ŌE =L	_	32	42	
	OE - OUTO	t _{pLH3}	6	LE=H	_	30	40	
Propagation	CLK-OUT1	t _{pHL1}	6	LE=H, \overline{OE} =L	-	44	54	ns
delay time	LE-OUT1	t _{pHL2}	6	ŌE =L	-	41	51	
	OE – OUT1	t _{pHL3}	6	LE=H	_	39	49	
	CLK-SOUT	t _{pHL}	6	_	_	20	25	
	CLK-OUT0	t _{pLH1}	6	LE=H, \overline{OE} =L	_	35	45	
Output rise time		t _{or}	6	10~90% of voltage waveform	-	35	41	ns
Output fall time		t _{of}	6	90~10% voltage waveform	_	40	52	ns

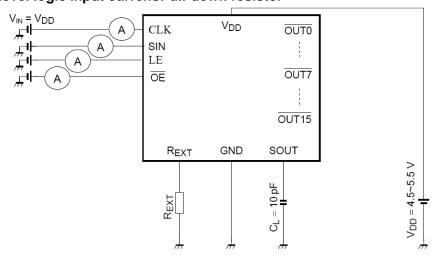
Test Circuit

Test Circuit1: High level logic input voltage/Low level logic input voltage

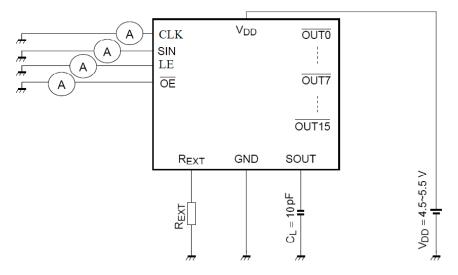




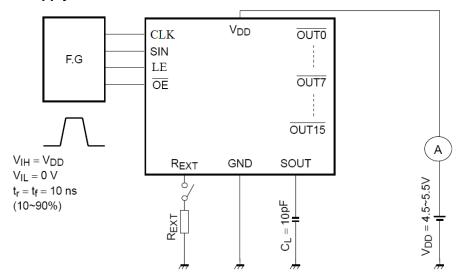
Test Circuit2: High level logic input current/Pull-down resistor



Test Circuit3: Low level logic input current/Pull-up resistor

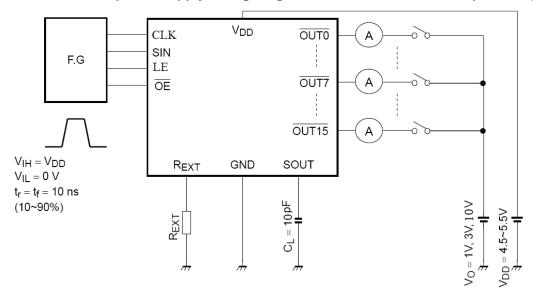


Test Circuit4: Power supply current

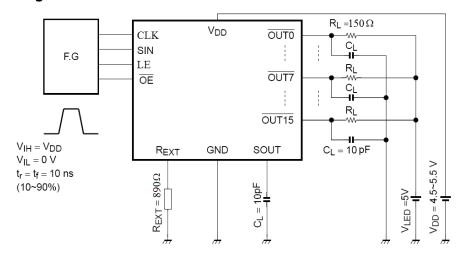




Test Circuit5: Constant current output/Output OFF leak current/Constant current error Constant current power supply voltage regulation/Constant current output voltage regulation



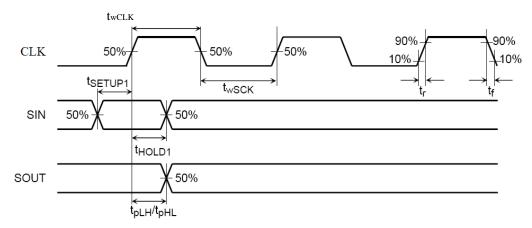
Test Circuit6: Switching Characteristics



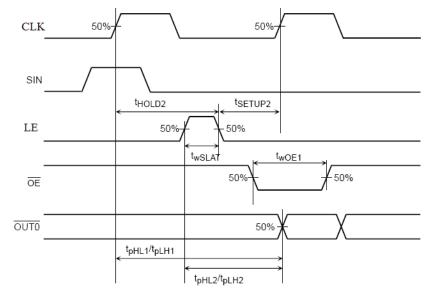


Timing Waveforms

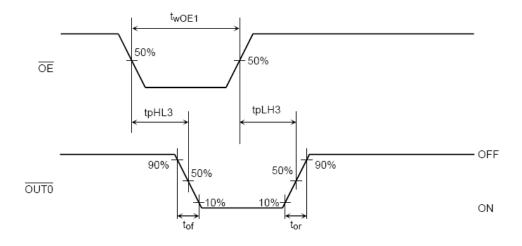
1. CLK, SIN, SOUT



2. CLK, SIN, LE, \overline{OE} , \overline{OUTO}



3. OUT0

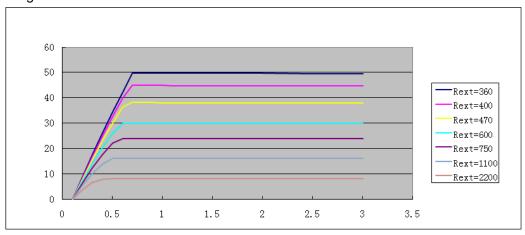




Application Information

ICN2027 exploits current precision controlling technology, and provides nearly no current variations from channel to channel and from IC to IC.

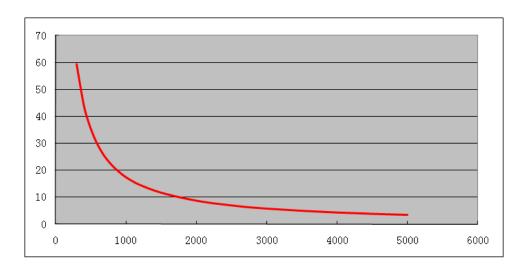
- 1) The maximum current variation between channels is less than ±1.3%, and that between ICs<±2.5%.
- 2) The current characteristic of output stage is flat, and can be kept constant regardless of the variations of LED forward voltages.



Setting Output Current

The output current (lout) of ICN2027 is set by an external resistor, Rext. The relationship between lout and Rext is

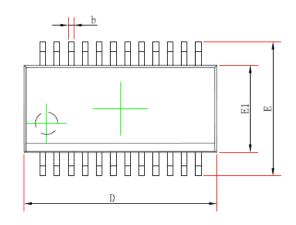
lout=
$$(V_{R-EXT}/R_{ext})*15$$
 $V_{R-EXT}=1.24V;$

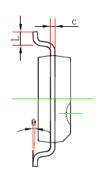


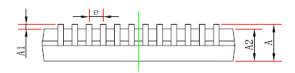


Package Outline

SSOP24 (150mil) PACKAGE OUTLINE DIMENSIONS

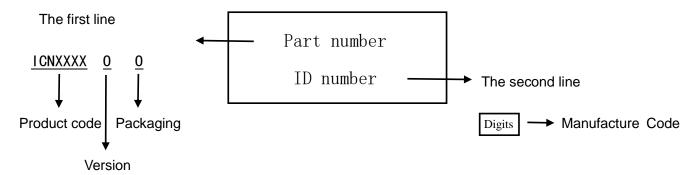






Symbol	Dimensions In	Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A		1.750		0.069	
A1	0.100	0.250	0.004	0.010	
A2	1. 250		0.049		
b	0. 203	0.305	0.008	0.012	
c	0.102	0. 254	0.004	0.010	
D	8.450	8.850	0.333	0.348	
E1	3.800	4.000	0.150	0. 157	
E	5.800	6. 200	0. 228	0. 244	
e	0.635	(BSC)	0. 025	(BSC)	
L	0.400	1. 270	0.016	0.050	
θ	0°	8°	0°	8°	

IC Top-mark Information



Product Ordering Information

Product number	Package (Pb-Free)	Weight (g)
I CN2027BP	SS0P24-0. 635	0. 13



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